NIKO-SEM

N-Channel Enhancement Mode Field Effect Transistor

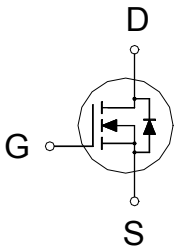
P0603BD

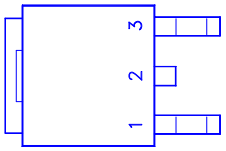
TO-252

Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
30	5.8mΩ	70A





1. GATE
2. DRAIN
3. SOURCE

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_C = 25 °C	I_D	70	A
	T_C = 100 °C		44	
Pulsed Drain Current[1]		I_{DM}	180	
Avalanche Current		I_{AS}	28	
Avalanche Energy	L = 0.3mH	E_{AS}	120	mJ
Power Dissipation	T_C = 25 °C	P_D	51	W
	T_C = 100 °C		20	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C
Lead Temperature ($^1/_{16}$" from case for 10 sec.)		T_L	275	

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.45	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	

[1]Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS (T_C = 25 °C, Unless Otherwise Noted)

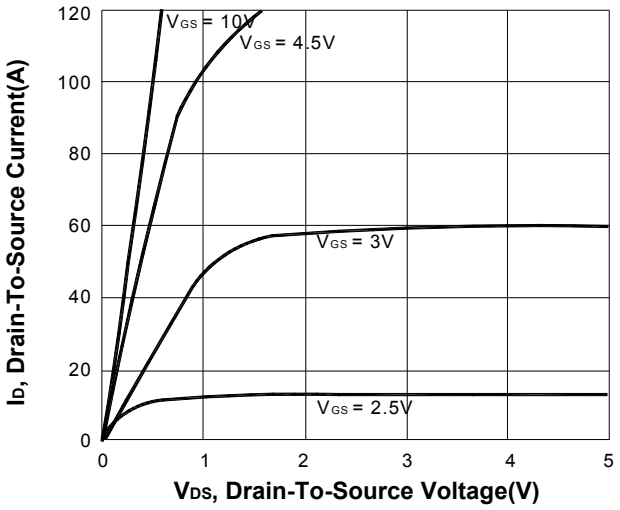
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1	1.6	3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±250	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24V, V_{GS} = 0V			1	μA
		V_{DS} = 20V, V_{GS} = 0V, T_J = 125 °C			10	

On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 10V, V_{GS} = 10V	70			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 30A		6.2	9	mΩ
		V_{GS} = 10V, I_D = 30A		4.6	5.8	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 20A		90		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 15V, f = 1MHz		2110		pF
Output Capacitance	C_{oss}			469		
Reverse Transfer Capacitance	C_{rss}			336		
Gate Resistance	Rg	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		1.4		Ω
Total Gate Charge[2]	Q_g	V_{DS} =15V, V_{GS} = 10V, I_D = 25A		44		nC
Gate-Source Charge[2]	Q_{gs}			8		
Gate-Drain Charge[2]	Q_{gd}			9		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DD} = 15V, $I_D \cong$ 25A, V_{GS} = 10V, R_{GEN} = 25Ω		23		nS
Rise Time[2]	t_r			36		
Turn-Off Delay Time[2]	$t_{d(off)}$			88		
Fall Time[2]	t_f			35		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I_S				39	A
Forward Voltage[1]	V_{SD}	I_F = I_S, V_{GS} = 0V			1.3	V
Reverse Recovery Time	t_{rr}	V_{GS} = 0V, dIs/dt= 100A/μs , I_S = 30 A		55		nS
Reverse Recovery Charge	Q_{rr}			25		nC

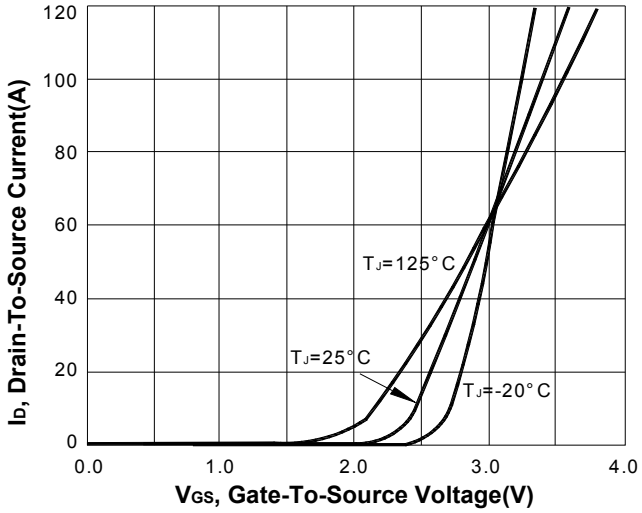
[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.

REMARK: THE PRODUCT MARKED WITH "P0603BD", DATE CODE or LOT #

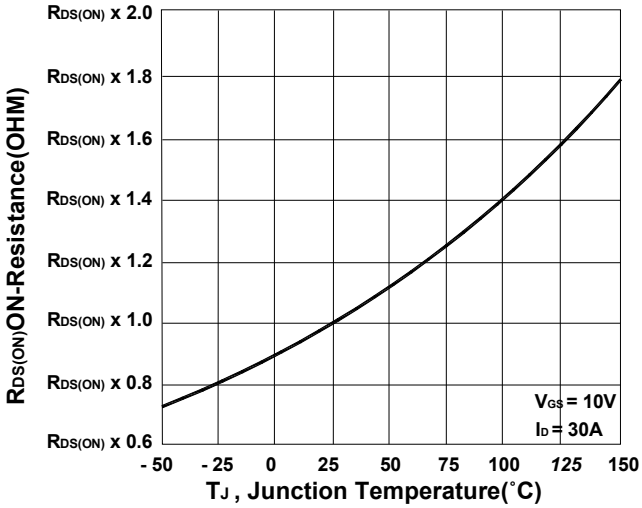
Output Characteristics



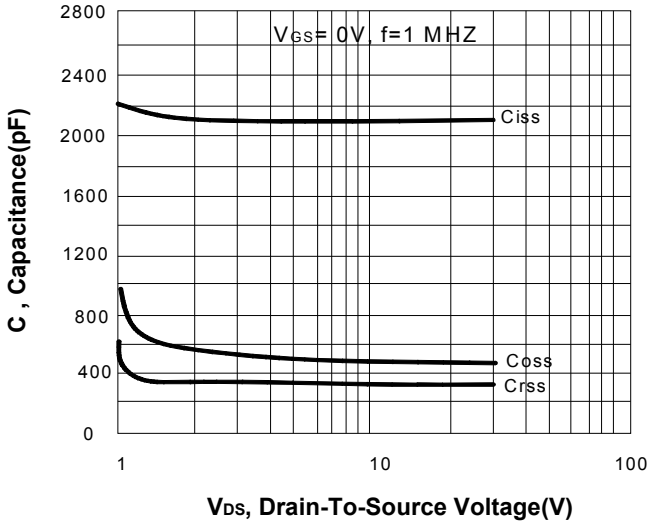
Transfer Characteristics



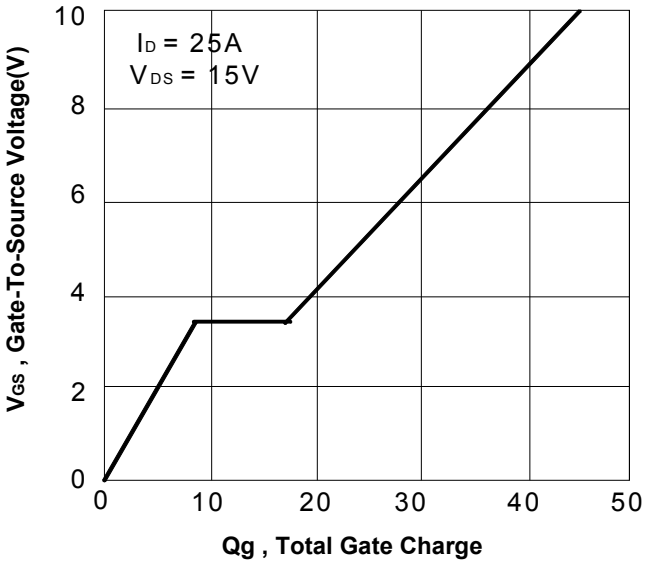
On-Resistance VS Temperature



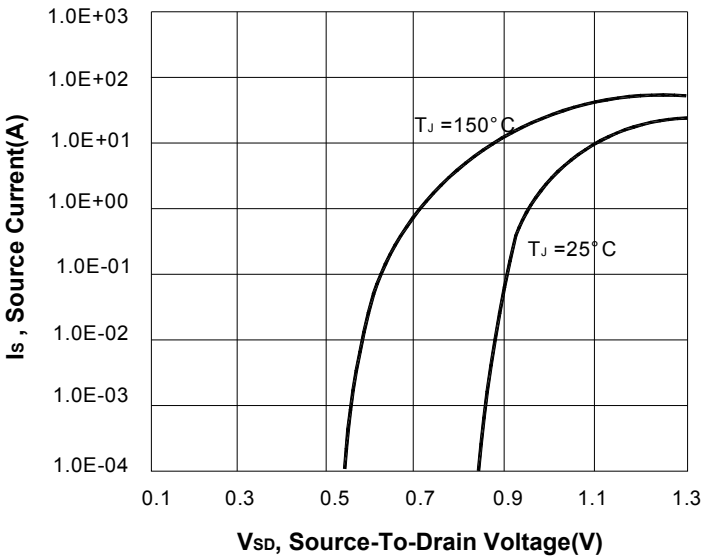
Capacitance Characteristic



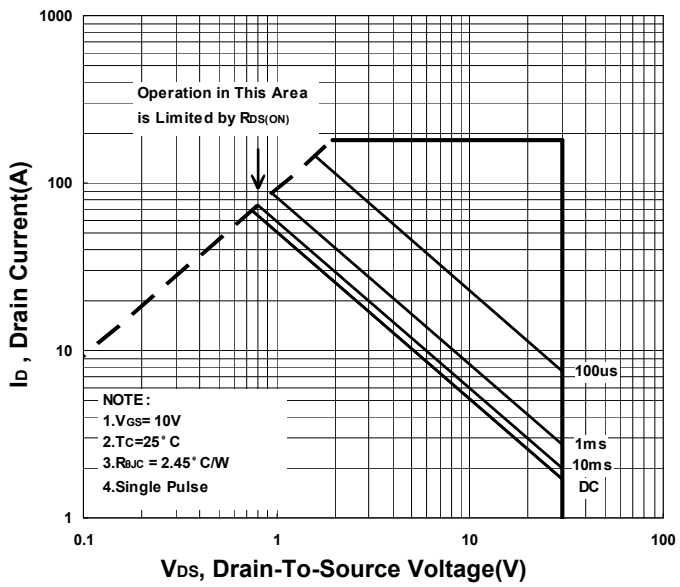
Gate charge Characteristics



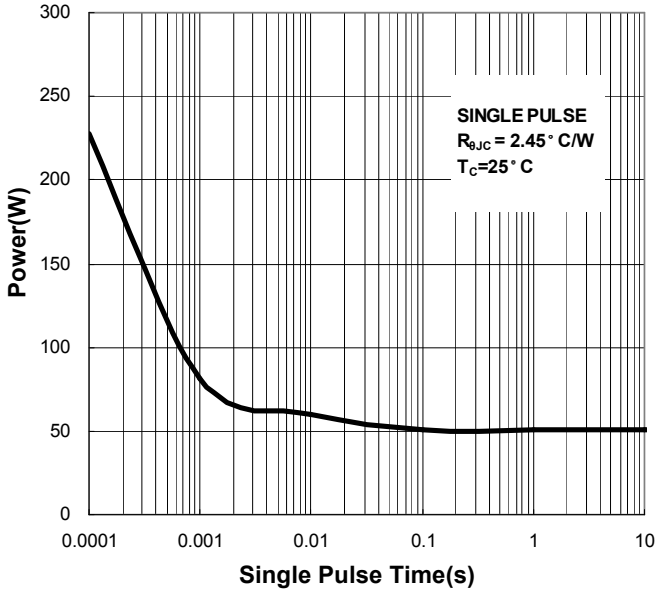
Source-Drain Diode Forward Voltage



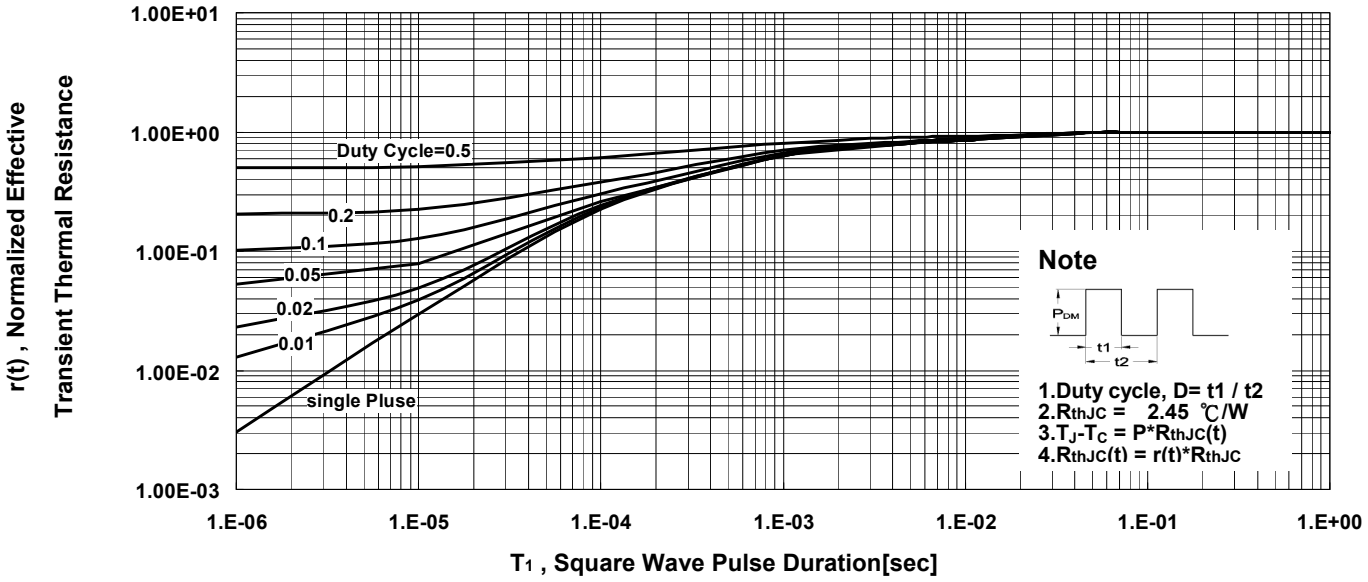
Safe Operating Area



Single Pulse Maximum Power Dissipation



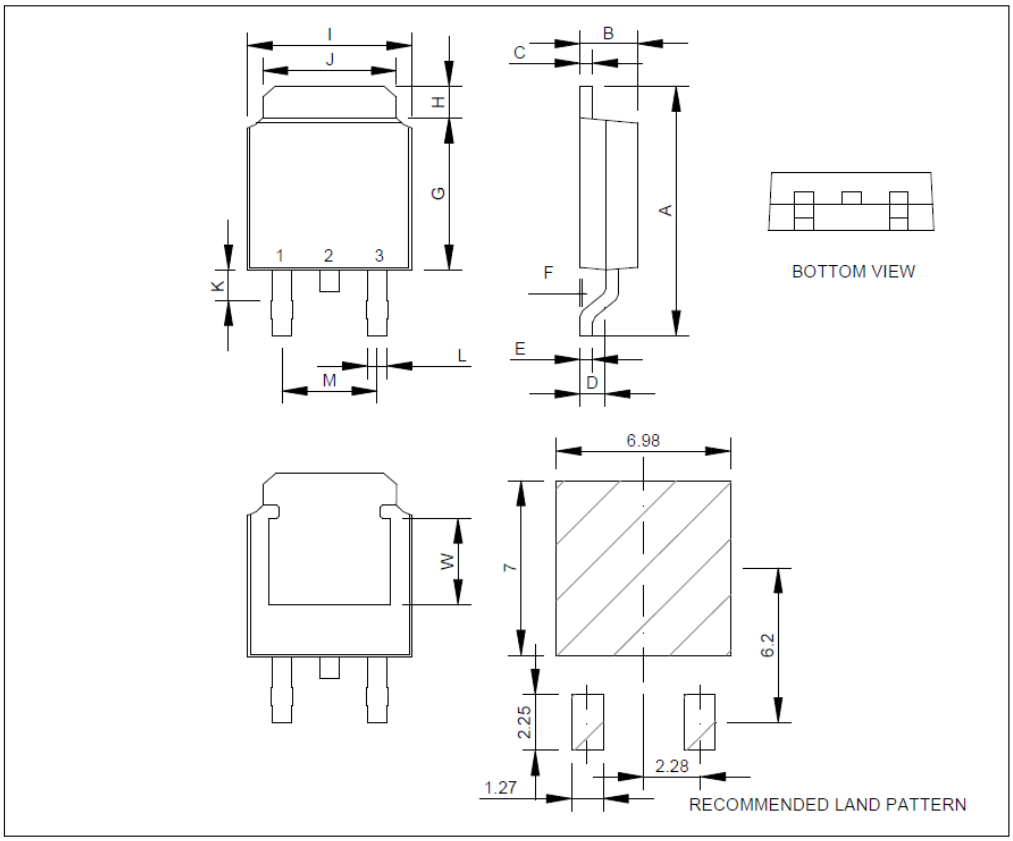
Transient Thermal Response Curve



Package Dimension

TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	9.5	10.4	H	0.8	1.27	2.03
B	2.19	2.3	2.435	I	6.35	6.6	6.8
C	0.35	0.5	0.65	J	4.8	5.34	5.5
D	0.89		1.5	K	0.5		1.5
E	0.35		0.65	L	0.4	0.76	0.89
F	0.0		0.23	M	3.96		5.18
G	5.4		6.2	W	3.38	3.58	3.78



TO-252 (DPAK) MECHANICAL DATA 散熱片

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
S	4.57	5.249	5.6	U	1.4		3
T	3.81	4.064	5	V	0.95		1.1